62 mm C-Series module



Preliminary datasheet 62 mm C-Series module with CoolSiC[™] Trench MOSFET

Features

- · Electrical features
 - V_{DSS} = 1200 V
 - $I_{DN} = 180 \text{ A} / I_{DRM} = 360 \text{ A}$
 - High current density
 - Low switching losses
- Mechanical features
 - 4 kV AC 1 min insulation

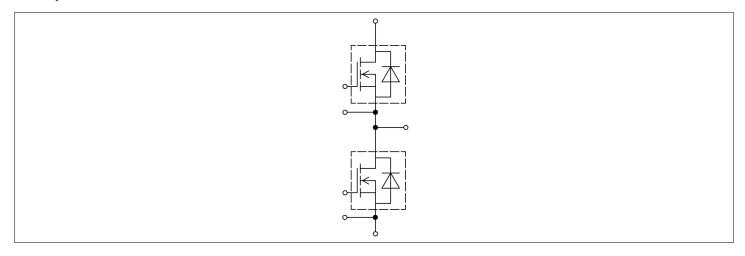
Potential applications

- UPS systems
- Solar applications
- DC/DC converter
- High-frequency switching application
- Energy storage systems
- DC charger for EV

Product validation

• Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description





62 mm C-Series module



Table of contents

Table of contents

	Description	1
	Features	1
	Potential applications	1
	Product validation	1
	Table of contents	2
1	Package	3
2	MOSFET	3
3	Body diode (MOSFET)	6
4	Characteristics diagrams	7
5	Circuit diagram	12
6	Package outlines	13
7	Module label code	14
	Revision history	15
	Disclaimer	16

62 mm C-Series module

1 Package



1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V _{ISOL}	RMS, f = 50 Hz, t = 60 s	4.0	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al ₂ O ₃	
Creepage distance	d_{Creep}	terminal to heatsink	29.0	mm
Creepage distance	d_{Creep}	terminal to terminal	23.0	mm
Clearance	d_{Clear}	terminal to heatsink	23.0	mm
Clearance	d _{Clear}	terminal to terminal	11.0	mm
Comparative tracking index	СТІ		> 400	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition			Values		Unit
				Min.	Тур.	Max.	
Stray inductance module	L _{sCE}				20		nH
Module lead resistance, terminals - chip	R _{CC'+EE'}	T_C = 25 °C, per switch			0.47		mΩ
Storage temperature	$T_{\rm stg}$			-40		125	°C
Mounting torque for module mounting	М	- Mounting according to valid application note	M6, Screw	3		6	Nm
Terminal connection torque	М	- Mounting according to valid application note	M6, Screw	2.5		5	Nm
Weight	G				340		g

2 MOSFET

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Drain-source voltage	V_{DSS}		T _{vj} = 25 °C	1200	V
Implemented drain current	I _{DN}			180	А
Continuous DC drain current	I _{DDC}	$T_{\rm vj}$ = 175 °C, $V_{\rm GS}$ = 18 V	T _C = 115 °C	140	А
Repetitive peak drain current	/ _{DRM}	verified by design, t _p limited by T _{vjmax}		360	А

(table continues...)





2 MOSFET

(continued) Maximum rated values Table 3

Parameter	Symbol	Note or test condition	Values	Unit
Gate-source voltage, max. transient voltage	V_{GS}	D < 0.01	-10/23	V
Gate-source voltage, max. static voltage	V _{GS}		-7/20	V

Table 4 **Recommended values**

Parameter	Symbol	Note or test condition	Values	Unit
On-state gate voltage	V _{GS(on)}		1518	V
Off-state gate voltage	V _{GS(off)}		-50	V

Table 5 **Characteristic values**

Parameter	Symbol	Note or test condition			Values		Unit
				Min.	Тур.	Max.	
Drain-source on-resistance	R _{DS(on)}	I _D = 180 A	$V_{\rm GS} = 18 \text{ V},$ $T_{\rm vj} = 25 ^{\circ}\text{C}$		5.5		mΩ
			V _{GS} = 18 V, T _{vj} = 125 °C		8.9		
			V _{GS} = 18 V, T _{vj} = 175 °C		11.8		
			$V_{\rm GS} = 15 \text{ V},$ $T_{\rm vj} = 25 ^{\circ}\text{C}$		6.6		
Gate threshold voltage	V _{GS(th)}	I_D = 60 mA, V_{DS} = V_{GS} , T_{Vj} = 25 °C, (tested after 1ms pulse at V_{GS} = +20 V)		3.45	4.3	5.15	V
Total gate charge	Q _G	$V_{\rm DD}$ = 800 V, $V_{\rm GS}$ = -3/18 V			0.446		μC
Internal gate resistor	R _{Gint}	T _{vj} = 25 °C			1.4		Ω
Input capacitance	C _{ISS}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$	T _{vj} = 25 °C		13.2		nF
Output capacitance	C _{OSS}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$	T _{vj} = 25 °C		0.63		nF
Reverse transfer capacitance	C _{rss}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$	T _{vj} = 25 °C		0.042		nF
C _{OSS} stored energy	E _{OSS}	$V_{\rm DS}$ = 800 V, $V_{\rm GS}$ = -3/18 V,	T _{vj} = 25 °C		258		μJ
Drain-source leakage current	I _{DSS}	$V_{\rm DS}$ = 1200 V, $V_{\rm GS}$ = -3 V	T _{vj} = 25 °C		0.09	527	μA
Gate-source leakage current	I _{GSS}	$V_{\rm DS} = 0 \text{ V}, T_{\rm vj} = 25 ^{\circ}\text{C}$	V _{GS} = 20 V			400	nA

(table continues...)

62 mm C-Series module

2 MOSFET



Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition			Values		Unit
				Min.	Тур.	Max.	
Turn-on delay time	$t_{\sf don}$	$I_{\rm D} = 180 \text{A}, R_{\rm Gon} = 3.9 \Omega,$	T _{vj} = 25 °C		60		ns
(inductive load)		$V_{\rm DD} = 600 \text{ V}, V_{\rm GS} = -3/18 \text{ V}$	T _{vj} = 125 °C		58		
			T _{vj} = 175 °C		58		
Rise time (inductive load)	t _r	$I_{\rm D} = 180 \text{A}, R_{\rm Gon} = 3.9 \Omega,$	T _{vj} = 25 °C		59		ns
		$V_{\rm DD} = 600 \text{ V}, V_{\rm GS} = -3/18 \text{ V}$	T _{vj} = 125 °C		59		
			T _{vj} = 175 °C		61		
Turn-off delay time	$t_{\sf doff}$	$I_{\rm D} = 180 \text{ A}, R_{\rm Goff} = 3.6 \Omega,$	T _{vj} = 25 °C		101		ns
(inductive load)		<u> </u>	T _{vj} = 125 °C		108		
			T _{vj} = 175 °C		111		
Fall time (inductive load)	t _f	1/ - 000 1/ 1/ - 2/10 1/	T _{vj} = 25 °C		29		ns
	$V_{\rm DD} = 600 \text{V}, V_{\rm GS} = -3 \text{C}$		T _{vj} = 125 °C		29		
			T _{vj} = 175 °C		29		
Turn-on energy loss per	E_{on}	$E_{\rm on}$ $I_{\rm D}$ = 180 A, $V_{\rm DD}$ = 600 V, $L_{\rm \sigma}$ = 10 nH, $V_{\rm GS}$ = -3/18 V, $R_{\rm Gon}$ = 3.9 Ω, di/dt = 5.5	T _{vj} = 25 °C		2.8		mJ
pulse			T _{vj} = 125 °C		3.2		
		$kA/\mu s (T_{vj} = 175 °C)$	T _{vj} = 175 °C		3.6		
Turn-off energy loss per	$E_{ m off}$	$I_{\rm D}$ = 180 A, $V_{\rm DD}$ = 600 V,	T _{vj} = 25 °C		2.9		mJ
pulse		$L_{\sigma} = 10 \text{ nH}, V_{GS} = -3/18 \text{ V},$ $R_{Goff} = 3.6 \Omega, \text{ dv/dt} = 16.6$	T _{vj} = 125 °C		3.1		
		$kV/\mu s (T_{vj} = 175 °C)$	T _{vj} = 175 °C		3.3		
Thermal resistance, junction to case	R_{thJC}	per MOSFET				0.188	K/W
Thermal resistance, case to heat sink	R_{thCH}	per MOSFET, $\lambda_{grease} = 1 \text{ W}$	/(m·K)		0.0420		K/W
Temperature under switching conditions	$T_{\rm vjop}$			-40		175	°C

Note:

The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Notes AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

Tvj,op > 150°C is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13.

62 mm C-Series module



3 Body diode (MOSFET)

3 Body diode (MOSFET)

Table 6 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
DC body diode forward	I _{SD}	$T_{\rm vj}$ = 175 °C, $V_{\rm GS}$ = -3 V	T _C = 115 °C	75	Α
current					

Table 7 Characteristic values

Parameter	Symbol	Note or test condition		bol Note or test condition Values			Unit	Unit
				Min.	Тур.	Max.		
Forward voltage	V _{SD}	$I_{SD} = 180 \text{ A}, V_{GS} = -3 \text{ V}$	T _{vj} = 25 °C		4.35	5.75	V	
			T _{vj} = 125 °C		4.05			
			T _{vj} = 175 °C		3.95			

4 Characteristics diagrams

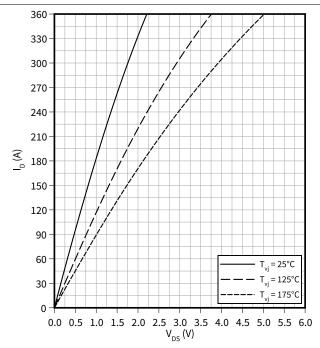


4 Characteristics diagrams

Output characteristic (typical), MOSFET

 $I_D = f(V_{DS})$

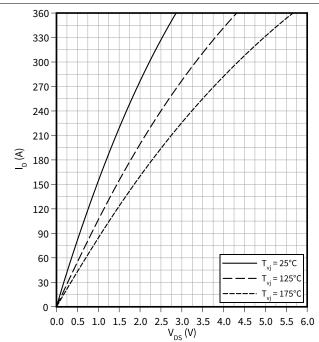
 $V_{GS} = 18 V$



Output characteristic (typical), MOSFET

 $I_D = f(V_{DS})$

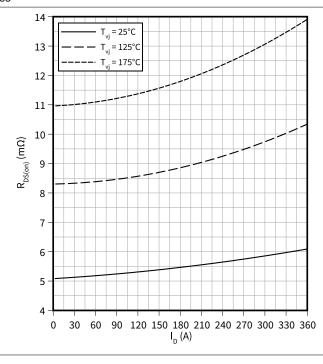
 $V_{GS} = 15 V$



Drain source on-resistance (typical), MOSFET

 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})} = \mathsf{f}(\mathsf{I}_\mathsf{D})$

 $V_{GS} = 18 V$

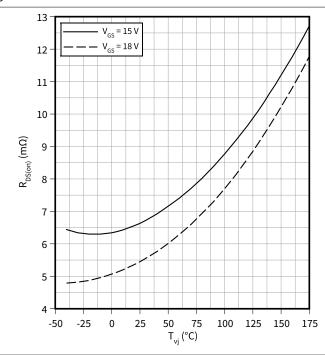


Drain source on-resistance (typical), MOSFET

 $R_{DS(on)} = f(T_{vj})$

 $I_D = 180 A$

7



62 mm C-Series module

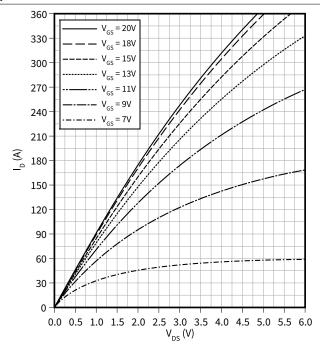


4 Characteristics diagrams

Output characteristic field (typical), MOSFET

 $I_D = f(V_{DS})$

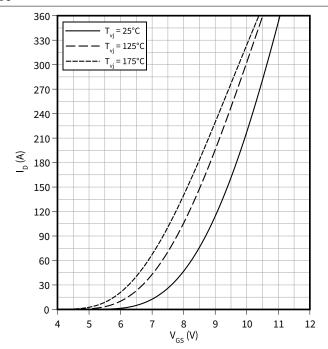
 $T_{vj} = 175 \,^{\circ}\text{C}$



Transfer characteristic (typical), MOSFET

 $I_D = f(V_{GS})$

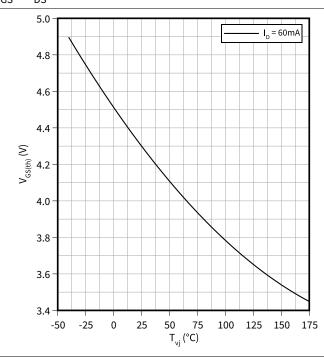
 $V_{DS} = 20 V$



Gate-source threshold voltage (typical), MOSFET

 $V_{GS(th)} = f(T_{vj})$

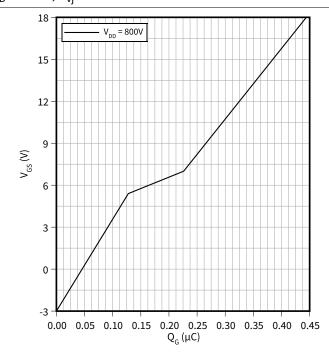
 $V_{GS} = V_{DS}$



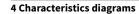
Gate charge characteristic (typical), MOSFET

 $V_{GS} = f(Q_G)$

 $I_D = 180 A$, $T_{vi} = 25 °C$



62 mm C-Series module

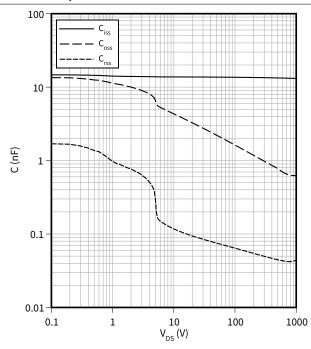




Capacity characteristic (typical), MOSFET

 $C = f(V_{DS})$

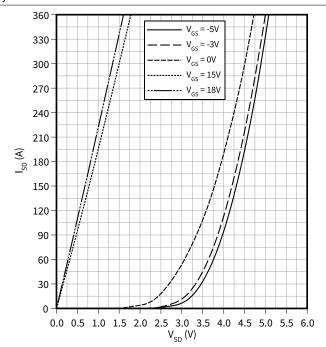
f = 100 kHz, $T_{vi} = 25 \,^{\circ}\text{C}$, $V_{GS} = 0 \,^{\circ}\text{V}$



Forward characteristic body diode (typical), MOSFET

 $I_{SD} = f(V_{SD})$

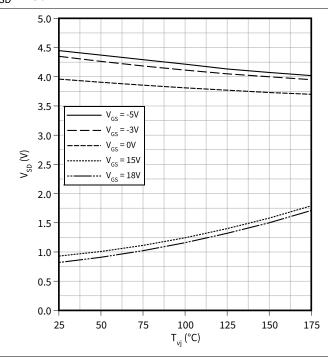
 T_{vj} = 25 °C



Forward voltage of body diode (typical), MOSFET

 $V_{SD} = f(T_{vi})$

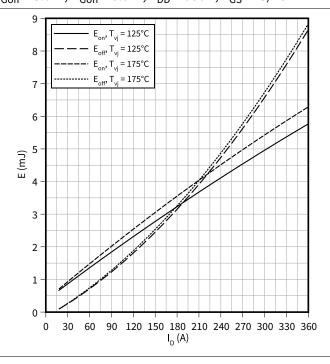
I_{SD} = 180 A



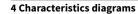
Switching losses (typical), MOSFET

 $E = f(I_D)$

 R_{Goff} = 3.6 Ω , R_{Gon} = 3.9 Ω , V_{DD} = 600 V, V_{GS} = -3/18 V



62 mm C-Series module

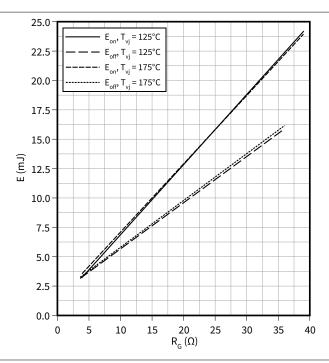




Switching losses (typical), MOSFET

 $E = f(R_G)$

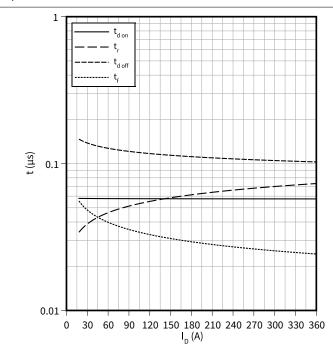
$$V_{DD} = 600 \text{ V}, I_D = 180 \text{ A}, V_{GS} = -3/18 \text{ V}$$



Switching times (typical), MOSFET

 $t = f(I_D)$

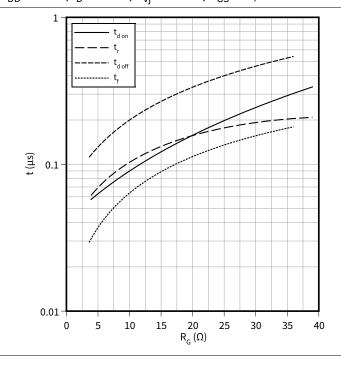
 R_{Goff} = 3.6 $\Omega,\,R_{Gon}$ = 3.9 $\Omega,\,V_{DD}$ = 600 V, T_{vj} = 175 °C, V_{GS} = -3/18 V



Switching times (typical), MOSFET

 $t = f(R_c)$

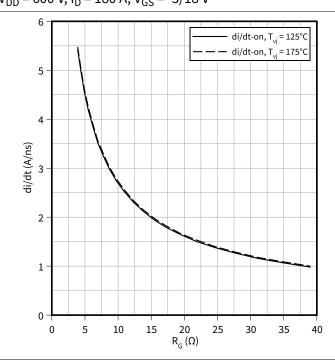
$$V_{DD}$$
 = 600 V, I_{D} = 180 A, T_{vj} = 175 °C, V_{GS} = -3/18 V



Current slope (typical), MOSFET

 $di/dt = f(R_G)$

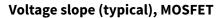
 $V_{DD} = 600 \text{ V}, I_D = 180 \text{ A}, V_{GS} = -3/18 \text{ V}$



62 mm C-Series module

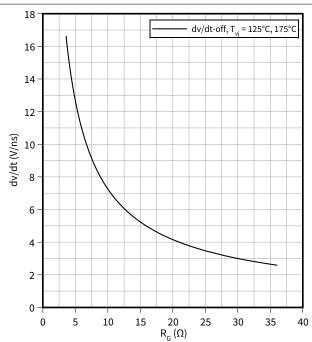


4 Characteristics diagrams



 $dv/dt = f(R_G)$

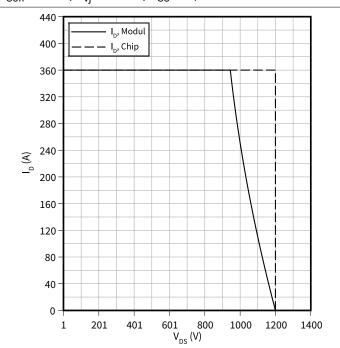
$$V_{DD}$$
 = 600 V, I_{D} = 180 A, V_{GS} = -3/18 V



Reverse bias safe operating area (RBSOA), MOSFET

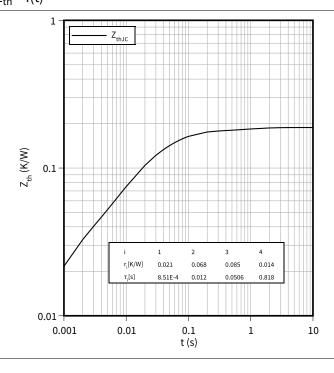
 $I_D = f(V_{DS})$

$$R_{Goff} = 3.6 \Omega$$
, $T_{vj} = 175 \,^{\circ}\text{C}$, $V_{GS} = -3/18 \,^{\circ}\text{V}$



${\bf Transient\ thermal\ impedance\ ,\ MOSFET}$

$$Z_{th} = f(t)$$





5 Circuit diagram

5 Circuit diagram

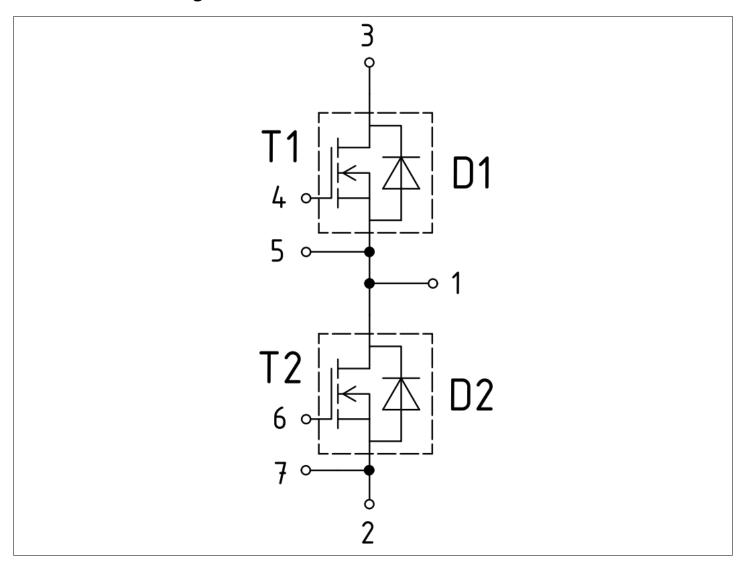


Figure 1

6 Package outlines



6 Package outlines

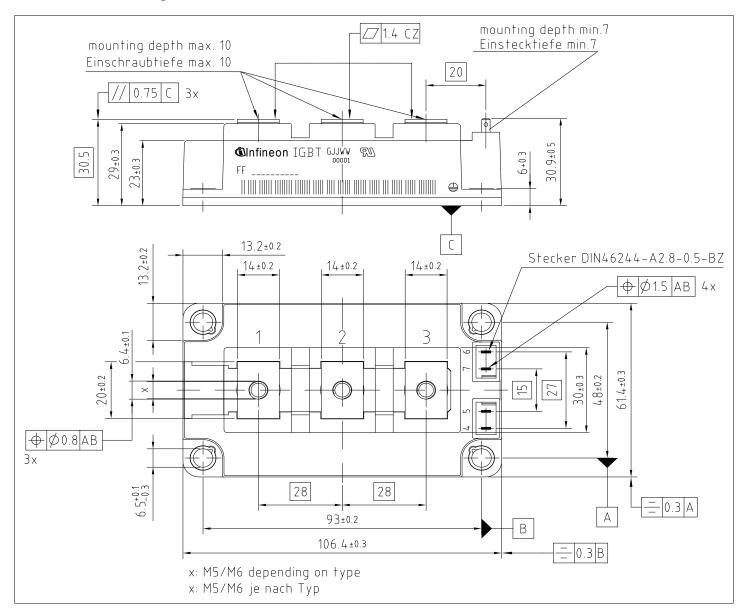
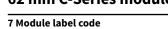


Figure 2

62 mm C-Series module





7 Module label code

Code format	Data Matrix		Barcode 0	Code128
Encoding	ASCII text		Code Set	A
Symbol size	16x16		23 digits	
Standard	IEC24720 and IEC16022		IEC8859-1	
Code content	Content Module serial number Module material number Production order number Date code (production year) Date code (production week) Digit 1 - 5 6 - 11 12 - 19 20 - 21 20 - 21 21 - 23			Example 71549 142846 55054991 15 30
Example	71549142846550549911530		7154014294	#6550549911530

Figure 3

62 mm C-Series module



Revision history

Revision history

Document revision	Date of release	Description of changes
0.10	2023-03-17	Initial version

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2023-03-17 Published by Infineon Technologies AG 81726 Munich, Germany

© 2023 Infineon Technologies AG All Rights Reserved.

Do you have a question about any aspect of this document?

 ${\bf Email: erratum@infineon.com}$

Document reference IFX-ABF583-001

Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.